

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	200	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>R</sub>		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	140	V
Average Rectified Output Current (See Figure 4)	I <sub>O</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	30	A

## Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Power Dissipation (Note 6) @ T <sub>A</sub> = +25°C	P <sub>D</sub>	—	1.0	W
Thermal Resistance Junction to Soldering Point (Note 7)	R <sub>θJS</sub>	—	6	°C/W
Thermal Resistance Junction to Ambient (Note 6) @ T <sub>A</sub> = +25°C	R <sub>θJA</sub>	116	—	°C/W
Thermal Resistance Junction to Ambient (Note 8) @ T <sub>A</sub> = +25°C	R <sub>θJA</sub>	182	—	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150		°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Minimum Reverse Breakdown Voltage @ I <sub>R</sub> = 5μA	V <sub>(BR)</sub>	200	V
Maximum Forward Voltage Drop @ I <sub>F</sub> = 0.6A	V <sub>FM</sub>	0.90	V
@ I <sub>F</sub> = 1.0A		0.98	
Peak Reverse Current @ T <sub>A</sub> = +25°C	I <sub>RM</sub>	5.0	μA
at Rated DC Blocking Voltage (Note 5) @ T <sub>A</sub> = +100°C		200	
Reverse Recovery Time (Note 9)	t <sub>RR</sub>	25	ns
Typical Total Capacitance (f = 1MHz, V <sub>R</sub> = 4VDC)	C <sub>T</sub>	27	pF

- Notes:
5. Short duration pulse test used to minimize self-heating effect.
  6. Device mounted on 1" x 1", Polyimide PCB; 2 oz. Cu pad layout as shown on Diodes Incorporated's website <http://www.diodes.com/package-outlines.html>.
  7. Theoretical R<sub>θJS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
  8. Device mounted on FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  9. Measured with I<sub>F</sub> = 0.5A, I<sub>R</sub> = 1.0A, I<sub>RR</sub> = 0.25A. See figure 7.

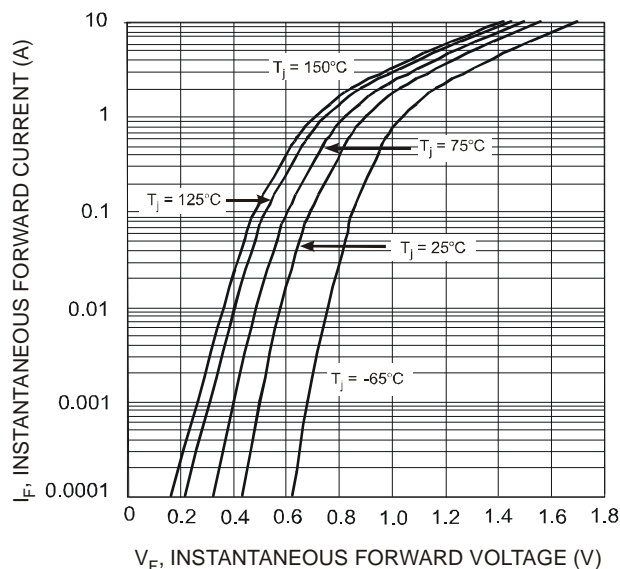


Fig. 1 Typical Forward Characteristics

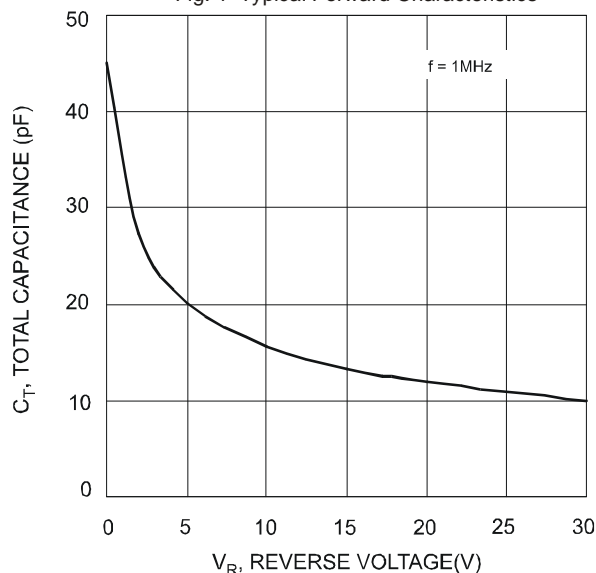


Fig. 3 Typical Total Capacitance

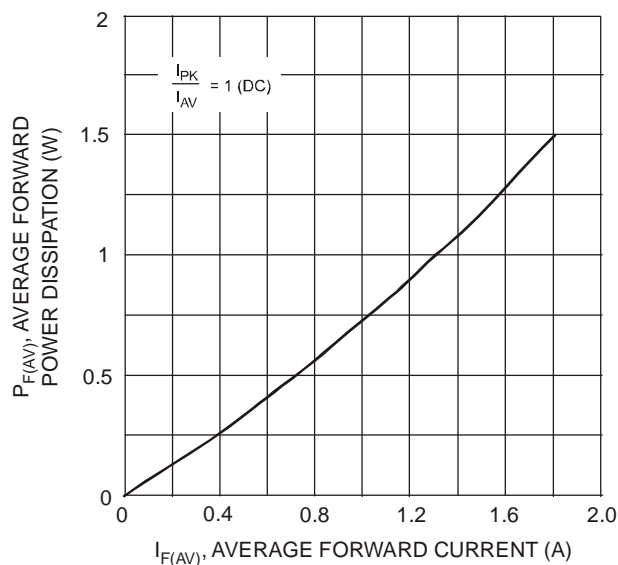


Fig. 5 Forward Power Dissipation

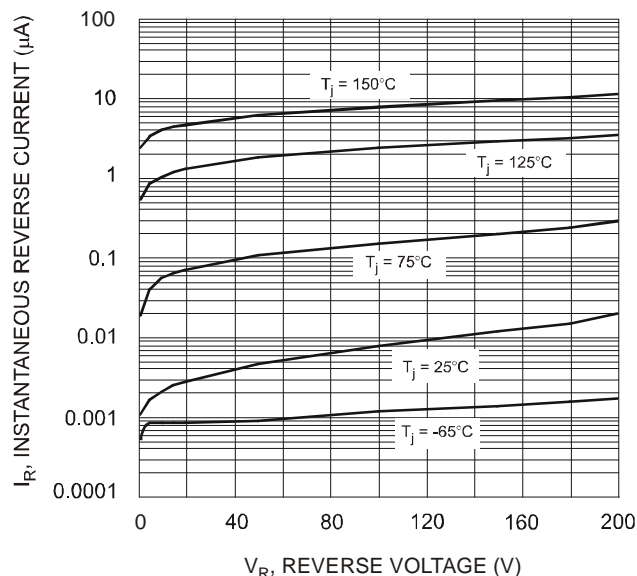


Fig. 2 Typical Reverse Characteristics

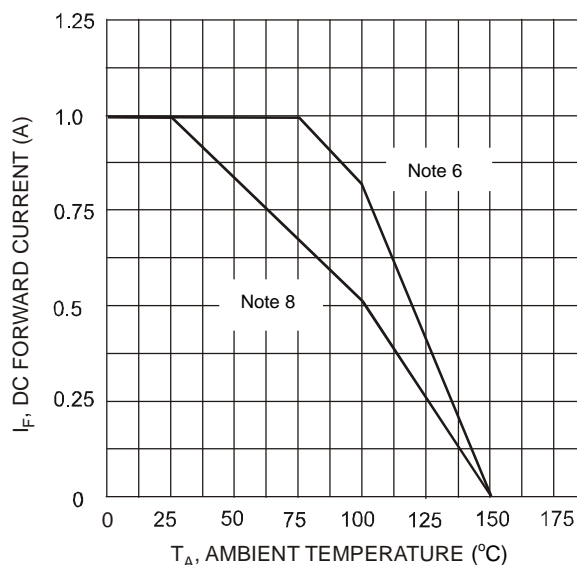


Fig. 4 DC Forward Current Derating

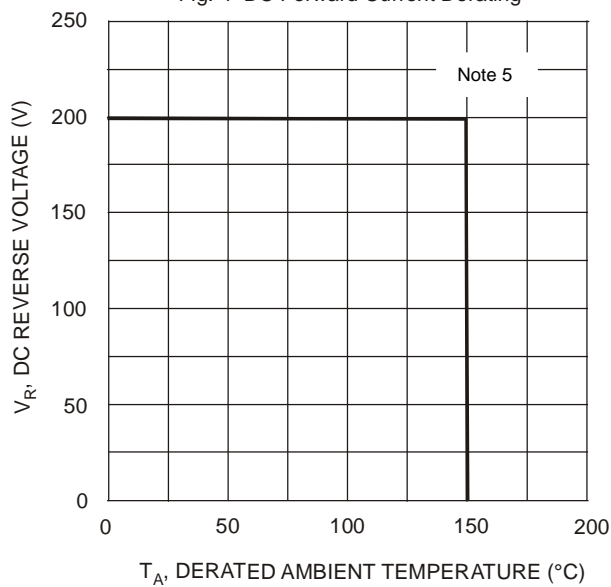
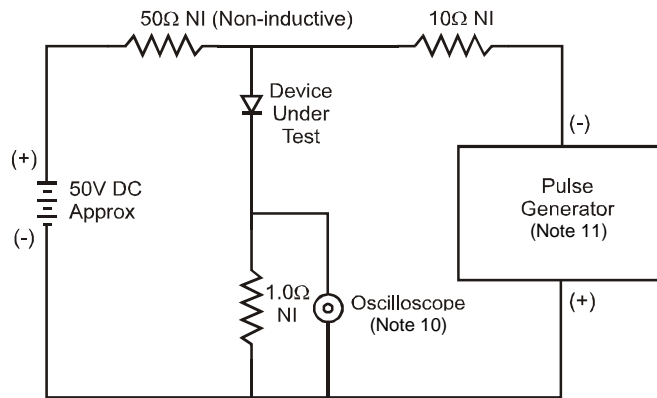
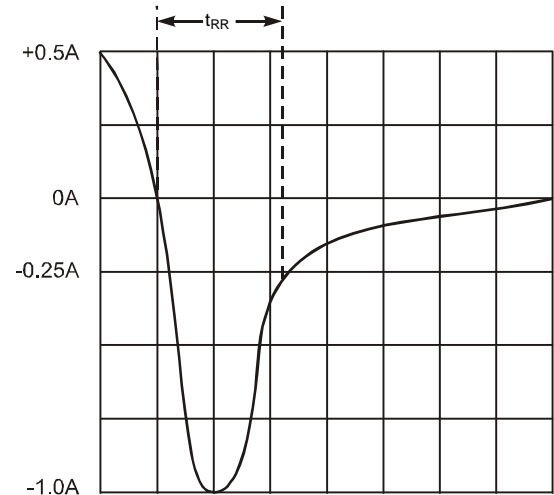


Fig. 6 Operating Temperature Derating



Notes:  
 10. Rise Time=7.0ns max. Input Impedance=1.0MΩ. 22pF.  
 11. Rise Time=10ns max. Input Impedance=50Ω.



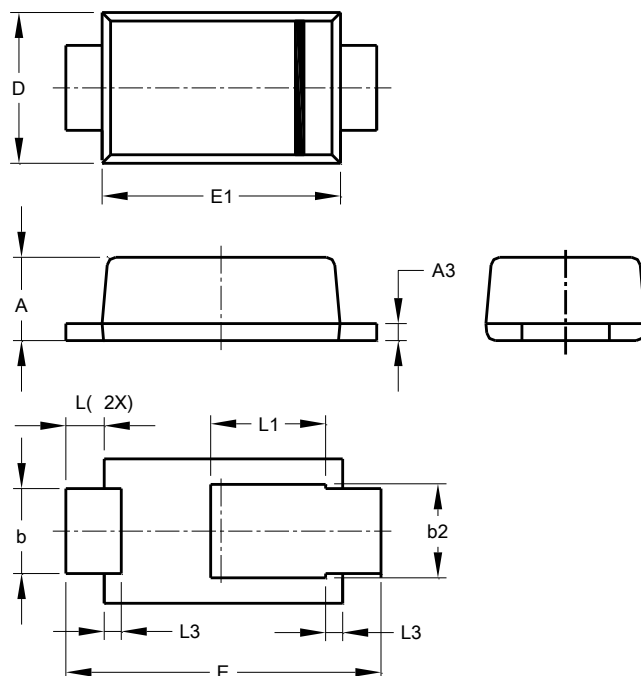
Set time base for 50/100 ns/cm

Fig. 7 Reverse Recovery Time Characteristic and Test Circuit

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI123**

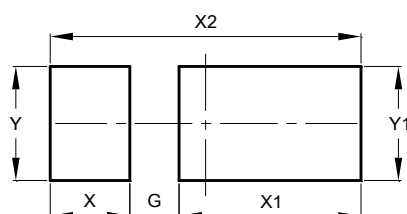


PowerDI123			
Dim	Min	Max	Typ
A	0.93	1.00	0.98
A3	0.15	0.25	0.20
b	0.85	1.25	1.00
b2	1.025	1.125	1.10
D	1.63	1.93	1.78
E	3.50	3.90	3.70
E1	2.60	3.00	2.80
L	0.40	0.50	0.45
L1	1.25	1.40	1.35
L3	0.125	0.275	0.20
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI123**



Dimensions	Value (in mm)
G	0.65
X	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

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